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# Micro-Stepping Motor Driver

#### Introduction

The AMIS-30532 is a micro-stepping stepper motor driver for bipolar stepper motors. The chip is connected through I/O pins and an SPI interface with an external microcontroller. It has an on-chip voltage regulator, reset-output and watchdog reset, able to supply peripheral devices. The AMIS-30532 contains a current-translation table and takes the next micro-step depending on the clock signal on the "NXT" input pin and the status of the "DIR" (=direction) register or input pin. The chip provides a so-called "speed and load angle" output. This allows the creation of stall detection algorithms and control loops based on load-angle to adjust torque and speed. It is using a proprietary PWM algorithm for reliable current control.

The AMIS-30532 is implemented in I2T100 technology, enabling both high-voltage analog circuitry and digital functionality on the same chip. The chip is fully compatible with the automotive voltage requirements.

The AMIS-30532 is ideally suited for general-purpose stepper motor applications in the automotive, industrial, medical, and marine environment. With the on-chip voltage regulator it further reduces the BOM for mechatronic stepper applications.

#### **Key Features**

- Dual H-Bridge for 2-Phase Stepper Motors
- Programmable Peak—Current up to 1.6 A Continuous<sup>†</sup> (3.0 A Short Time) using a 5-bit Current DAC
- On-Chip Current Translator
- SPI Interface
- Speed and Load Angle Output
- Seven Step Modes from Full-Step Up to 32 Micro-Steps
- Fully Integrated Current-Sense
- PWM Current Control with Automatic Selection of Fast and Slow Decay
- Low EMC PWM with Selectable Voltage Slopes
- Active Fly-Back Diodes
- Full Output Protection and Diagnosis
- Thermal Warning and Shutdown
- Compatible with 5 V and 3.3 V Microcontrollers
- Integrated 5 V Regulator to Supply External Microcontroller
- Integrated Reset Function to Reset External Microcontroller
- Integrated Watchdog Function
- These Devices are Pb-Free and are RoHS Compliant\*

†Output current level may be limited by ambient temperature and heat sinking. \*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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NQFP-32, 7x7 CASE 560AA

#### MARKING DIAGRAM



A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week

G = Pb-Free Designator CCCC = Country of Assembly

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 27 of this data sheet.

## **Block DIAGRAM**

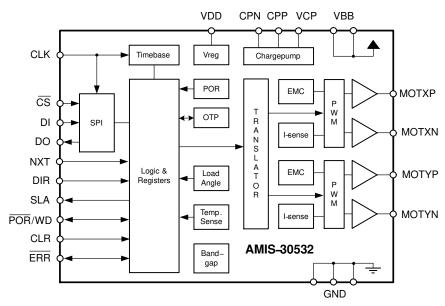


Figure 1. Block Diagram AMIS-30532

**Table 1. PIN LIST AND DESCRIPTION** 

Name	Pin	Description	Туре	Equivalent Schematic
GND	1	Ground	Supply	
DI	2	SPI Data In	Digital Input	Type 2
CLK	3	SPI Clock Input	Digital Input	Type 2
NXT	4	Next Micro-Step Input	Digital Input	Type 2
DIR	5	Direction Input	Digital Input	Type 2
ERR	6	Error Output (Open Drain)	Digital Output	Type 4
SLA	7	Speed Load Angle Output	Analog Output	Type 5
/	8	No Function (to be left open in normal operation)		
CPN	9	Negative Connection of Charge Pump Capacitor	High Voltage	
CPP	10	Positive Connection of Charge Pump Capacitor	High Voltage	
VCP	11	Charge-Pump Filter-Capacitor	High Voltage	
CLR	12	"Clear" = Chip Reset Input	Digital Input	Type 1
CS	13	SPI Chip Select Input	Digital Input	Type 2
VBB	14	High Voltage Supply Input	Supply	Type 3
MOTYP	15, 16	Negative End of Phase Y Coil Output	Driver Output	
GND	17, 18	Ground, Heat Sink	Supply	
MOTYN	19, 20	Positive End of Phase Y Coil Output	Driver Output	
MOTXN	21, 22	Positive End of Phase X Coil Output	Driver Output	
GND	23, 24	Ground, Heat Sink	Supply	
MOTXP	25, 26	Negative End of Phase X Coil Output	Driver Output	
VBB	27	High Voltage Supply Input	Supply	Type 3
/	30	No Function (to be left open in normal operation)		
POR/WD	28	Power-On-Reset and Watchdog Reset Output (Open Drain)	Digital Output	Type 2
TST0	29	Test Pin Input (to be tied to ground in normal operation)	Digital Input	
DO	31	SPI Data Output (Open Drain)	Digital Output	Type 4
VDD	32	Logic Supply Output (needs external decoupling capacitor)	Supply	Type 6

#### **PIN DESCRIPTION**

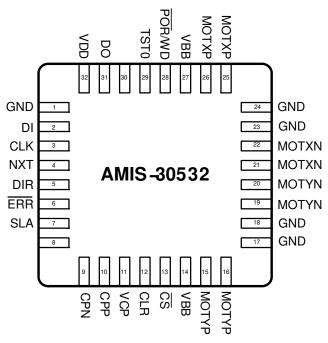


Figure 2. Pin Out AMIS-30532

**Table 2. ABSOLUTE MAXIMUM RATINGS** 

Symbol	Parameter	Min	Max	Unit
V <sub>BB</sub>	Analog DC Supply Voltage (Note 1)	-0.3	+40	V
T <sub>ST</sub>	Storage Temperature	-55	+160	°C
$T_J$	Junction Temperature under bias (Note 2)	-50	+175	°C
V <sub>ESD</sub>	Electrostatic discharges on component level, All pins (Note 3)	-2	+2	kV
V <sub>ESD</sub>	Electrostatic discharges on component level, HiV pins (Note 4)	-8	+8	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

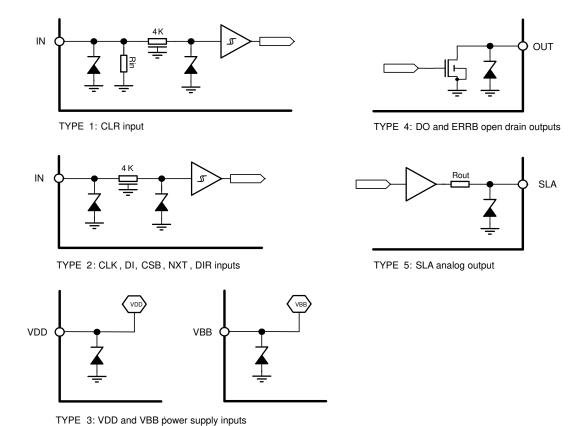
- 1. For limited time < 0.5 s.
- 2. Circuit functionality not guaranteed.
- Human Body Model (100 pF via 1.5 kΩ, according to JEDEC EIA–JESD22–A114–B).
   HiV = High Voltage Pins MOTxx, V<sub>BB</sub>, GND; (100 pF via 1.5 kΩ, according to JEDEC EIA–JESD22–A114–B).

**Table 3. THERMAL RESISTANCE** 

	Thermal resis	stance		
	Junction – to – Ambient			
Package	Junction – to – Exposed Pad	1S0P board	2S2P board	Unit
NQFP-32	0,95	60	30	K/W

#### **EQUIVALENT SCHEMATICS**

Following figure gives the equivalent schematics of the user relevant inputs and outputs. The diagrams are simplified representations of the circuits used.



### PACKAGE THERMAL CHARACTERISTICS

Figure 3. In- and Output Equivalent Diagram

The AMIS-30532 is available in a NQFP32 package. For cooling optimizations, the NQFP has an exposed thermal pad which has to be soldered to the PCB ground plane. The ground plane needs thermal vias to conduct the heat to the bottom layer. Figure 3 gives an example for good power distribution solutions.

For precise thermal cooling calculations the major thermal resistances of the device are given. The thermal media to which the power of the devices has to be given are:

- Static environmental air (via the case)
- PCB board copper area (via the exposed pad)

The thermal resistances are presented in Table 5: DC Parameters.

The major thermal resistances of the device are the Rth from the junction to the ambient (Rthja) and the overall Rth from the junction to exposed pad (Rthjp). In Table 5 below one can find the values for the Rthja and Rthjp, simulated according to JESD-51:

The Rthja for 2S2P is simulated conform JEDEC JESD-51 as follows:

- A 4-layer printed circuit board with inner power planes and outer (top and bottom) signal layers is used
- Board thickness is 1.46 mm (FR4 PCB material)
- The 2 signal layers: 70 μm thick copper with an area of 5500 mm<sup>2</sup> copper and 20% conductivity
- The 2 power internal planes: 36 µm thick copper with an area of 5500 mm<sup>2</sup> copper and 90% conductivity The Rthja for 1S0P is simulated conform to JEDEC JESD-51 as follows:
- A 1-layer printed circuit board with only 1 layer
- Board thickness is 1.46 mm (FR4 PCB material)
- The layer has a thickness of 70 μm copper with an area of 5500 mm<sup>2</sup> copper and 20% conductivity

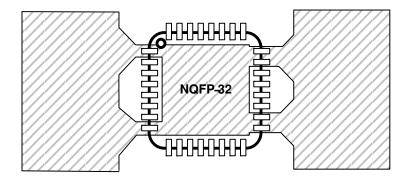


Figure 4. Example of NQFP-32 PCB Ground Plane Layout in Top View (Preferred Layout at Top and Bottom)

## **ELECTRICAL SPECIFICATION**

## **Recommend Operation Conditions**

Operating ranges define the limits for functional operation and parametric characteristics of the device. Note that the functionality of the chip outside these operating

ranges is not guaranteed. Operating outside the recommended operating ranges for extended periods of time may affect device reliability.

**Table 4. OPERATING RANGES** 

Symbol	Parameter	Min	Max	Unit
V <sub>BB</sub>	Analog DC Supply	+6	+30	٧
TJ	Junction Temperature (Note 5)	-40	+172	°C

<sup>5.</sup> No more than 100 cumulative hours in life time above  $T_{tw}$ .

**Table 5. DC PARAMETERS** (The DC parameters are given for V<sub>BB</sub> and temperature in their operating ranges unless otherwise specified) Convention: currents flowing in the circuit are defined as positive.

Symbol	Pin(s)	Parameter	Remark/Test Conditions	Min	Тур	Max	Unit
SUPPLY AN	D VOLTAGE	REGULATORS					
$V_{BB}$		Nominal operating supply range		6		30	V
I <sub>BB</sub>	$V_{BB}$	Total current consumption (Note 6)	Unloaded outputs			8	mA
$V_{DD}$		Regulated output voltage		4.50	5	5.50	V
I <sub>INT</sub>		Internal load current (Note 6)	Unloaded outputs			8	mA
I <sub>LOAD</sub>	V	Max output current (external and	6 V < V <sub>BB</sub> < 8 V	20			mA
	$V_{DD}$	internal loads)	8 V < V <sub>BB</sub> < 30 V	50			mA
I <sub>DDLIM</sub>		Current limitation	Pin shorted to ground			150	mA
I <sub>LOAD_PD</sub>		Output current in powerdown		1			mA
POWER-ON	-RESET (P	OR)					
$V_{DDH}$	V	Internal POR comparator threshold	V <sub>DD</sub> rising	4.0	4.25	4.4	V
$V_{\mathrm{DDL}}$	$V_{DD}$	Internal POR comparator threshold	V <sub>DD</sub> falling		3.68		V
MOTORDRIN	/ER						
I <sub>MDmax,Peak</sub>		Max current through motor coil in normal operation			3015		mA
I <sub>MDmax,RMS</sub>		Max RMS current through coil in normal operation			2132		mA
I <sub>MDabs</sub>		Absolute error on coil current		-10		10	%
I <sub>MDrel</sub>		Error on current ratio I <sub>coilx</sub> / I <sub>coily</sub>		-7		7	%
I <sub>SET_TC1</sub>		Temperature coefficient of coil current set-level, CUR[4:0] = 027	$-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 160^{\circ}\text{C}$		-250		ppm/k
I <sub>SET_TC2</sub>		Temperature coefficient of coil current set-level, CUR[4:0] = 2831	$-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 160^{\circ}\text{C}$		-460		ppm/k
R <sub>HS</sub>	MOTXP MOTXN	On–resistance high–side driver,	V <sub>BB</sub> = 12 V, T <sub>J</sub> = 27°C			0.35	Ω
	MOTYP	CUR[4:0] = 031 (Note 7)	V <sub>BB</sub> = 12 V, T <sub>J</sub> = 160°C		0.47	0.70	Ω
R <sub>LS3</sub>	MOTYN	On–resistance low–side driver,	$V_{BB} = 12 \text{ V}, T_{J} = 27^{\circ}\text{C}$			0.35	Ω
		CUR[4:0] = 2331 (Note 7)	V <sub>BB</sub> = 12 V, T <sub>J</sub> = 160°C		0.56	0.70	Ω
R <sub>LS2</sub>		On–resistance low–side driver,	$V_{BB} = 12 \text{ V}, T_{J} = 27^{\circ}\text{C}$			0.65	Ω
		CUR[4:0] = 1622 (Note 7)	V <sub>BB</sub> = 12 V, T <sub>J</sub> = 160°C		0.9	1.25	Ω
R <sub>LS1</sub>		On–resistance low–side driver,	$V_{BB} = 12 \text{ V}, T_{J} = 27^{\circ}\text{C}$			1.25	Ω
		CUR[4:0] = 915 (Note 7)	V <sub>BB</sub> = 12 V, T <sub>J</sub> = 160°C		1.7	2.5	Ω
R <sub>LS0</sub>		On–resistance low–side driver,	$V_{BB} = 12 \text{ V}, T_{J} = 27^{\circ}\text{C}$			2.5	Ω
		CUR[4:0] = 08 (Note 7)	V <sub>BB</sub> = 12 V, T <sub>J</sub> = 160°C		3.2	5.0	Ω
$I_{Mpd}$		Pulldown current	HiZ mode		5.0		mA
DIGITAL INP	UTS						
I <sub>leak</sub>	DI, CLK NXT, DIR	Input leakage (Note 8)	T <sub>J</sub> = 160°C			1	μΑ
V <sub>inL</sub>	CLR, CS	Logic low threshold		0		0.65	V
V <sub>inH</sub>		Logic high threshold		2.35		$V_{DD}$	V
R <sub>pd_CLR</sub>	CLR	Internal pulldown resistor		120		300	kΩ
R <sub>pd_TST</sub>	TST0	Internal pulldown resistor		3		9	kΩ

<sup>6.</sup> Current with oscillator running, all analogue cells active, SPI communication and NXT pulses applied. No floating inputs. Parameter guaranteed by design.
7. Characterization Data Only

<sup>8.</sup> Not valid for pins with internal pulldown resistor.

Table 5. DC PARAMETERS (The DC parameters are given for V<sub>BB</sub> and temperature in their operating ranges unless otherwise specified) Convention: currents flowing in the circuit are defined as positive.

Symbol	Pin(s)	Parameter	Remark/Test Conditions	Min	Тур	Max	Unit
DIGITAL O	JTPUTS		•			•	
V <sub>OL</sub>	DO, ERR, POR/WD	Logic Low level open drain	I <sub>OL</sub> = 5 mA			0.5	V
THERMAL	WARNING AI	ND SHUTDOWN					
$T_{tw}$		Thermal warning		138	145	152	°C
T <sub>tsd</sub>		Thermal shutdown (Notes 9 and 10)			T <sub>tw</sub> + 20		°C
CHARGE P	UMP			•	•	•	
V <sub>cp</sub>		Output voltage	6 V< V <sub>BB</sub> < 15 V		2*V <sub>BB</sub> -1.5		V
	VCP		15 V < V <sub>BB</sub> < 30 V	V <sub>BB</sub> +8	V <sub>BB</sub> +11.5	V <sub>BB</sub> +15	V
C <sub>buffer</sub>		External buffer capacitor		180	220	470	nF
C <sub>pump</sub>	CPP CPN	External pump capacitor		180	220	470	nF
PACKAGE '	THERMAL R	ESISTANCE VALUE					
Rth <sub>ja</sub>	NQFP	Thermal Resistance Junction-to- Ambient	Simulated Conform JEDEC JESD-51, (2S2P)		30		K/W
Rth <sub>jp</sub>	NQFP	Thermal Resistance Junction-to- Exposed Pad			0.95		K/W
SPEED ANI	LOAD ANG	SLE OUTPUT					
V <sub>out</sub>		Output Voltage Range		0.2		V <sub>DD</sub> - 0.2	V
V <sub>off</sub>	1	Output Offset SLA Pin	SLAG = 0	-50		50	mV
			SLAG = 1	-30		30	mV
G <sub>sla</sub>	SLA	Gain of SLA Pin = V <sub>BEMF</sub> /V <sub>coil</sub>	SLAG = 0		0.5		
			SLAG = 1		0.25		
R <sub>out</sub>		Output Resistance SLA Pin			0.23	1.0	kΩ
C <sub>LOAD</sub>		Load Capacitance SLA Pin				50	pF

<sup>9.</sup> No more than 100 cumulated hours in life time above  $T_{tw.}$  10. Thermal shutdown is derived from thermal warning Characterization Data Only.

 $\textbf{Table 6. AC PARAMETERS} \ (\textbf{The AC parameters are given for } V_{BB} \ \text{and temperature in their operating ranges})$ 

Symbol	Pin(s)	Parameter	Remark/Test Conditions	Min	Тур	Max	Unit
INTERNAL	OSCILLAT	OR			•		•
f <sub>osc</sub>		Frequency of internal oscillator		3.6	4.0	4.4	MHz
MOTORDR	RIVER						
f <sub>PWM</sub>		PWM frequency	Frequency depends only on	20.8	22.8	24.8	kHz
	PUMP  CPN CPP  CPN CPP  CPN CPP  MOTxx  CLR  Hard reset duration time  WD  POR /  WD  POR /  WD  Watchdog time out interval  Prohibited watchdog acknow controls  NCTION  Frequency of internal oscil frequency  PWM frequency  Double PWM frequency  PWM Jitter depth (Note 11  Turn-on voltage slope, 10  Turn-off voltage slope, 90  Output fall-time from VinH  EPUMP  CPN CPP  Charge pump frequency  NCTION  CLR  Hard reset duration time  POR /  WD  Watchdog time out interval  Prohibited watchdog acknow delay  NCTION  NXT Minimum, High Pulse	Double PWM frequency	internal oscillator	41.6	45.6	49.6	kHz
f <sub>d</sub>		PWM Jitter depth (Note 11)			10		% f <sub>PWM</sub>
Tb <sub>rise</sub>		Turn-on voltage slope, 10% to 90%	EMC[1:0] = 00		350		V/μs
	MOT		EMC[1:0] = 01		250		V/μs
	MOTXX		EMC[1:0] = 10		200		V/μs
			EMC[1:0] = 11		100		V/μs
Tb <sub>fall</sub>		Turn-off voltage slope, 90% to 10%	EMC[1:0] = 00		350		V/μs
	MOTYY		EMC[1:0] = 01		250		V/μs
MOTxx		EMC[1:0] = 10		200		V/μs	
			EMC[1:0] = 11		100		V/μs
DIGITAL O	UTPUTS				•		•
T <sub>H2L</sub>		Output fall-time from V <sub>inH</sub> to V <sub>inL</sub>	Capacitive load 400 pF and pullup resistor of 1.5 kΩ			50	ns
CHARGE F	PUMP						
f <sub>CP</sub>	CPN CPP	Charge pump frequency			250		kHz
T <sub>CPU</sub>	MOTxx	Start-up time of charge pump (Note 12)	Spec external components in Table 8			5	ms
CLR FUNC	TION				•		•
T <sub>CLR</sub>	CLR	Hard reset duration time		100			μS
POWERUP	)						
t <sub>PU</sub>	DOD /	Powerup time	$V_{BB}$ = 12 V, $I_{LOAD}$ = 50 mA, $C_{LOAD}$ = 220 nF			110	μS
t <sub>POR</sub>		Reset duration	See Figure 16		100		ms
t <sub>RF</sub>		Reset filter time	See Figure 16		1.0		μs
WATCHDO	G						
t <sub>WDTO</sub>		Watchdog time out interval		32		512	ms
t <sub>WDPR</sub>		Prohibited watchdog acknowledge delay			2.0		ms
NXT FUNC	TION						
t <sub>NXT_HI</sub>		NXT Minimum, High Pulse Width	See Figure 5	2.0			μS
t <sub>NXT_HI</sub>	1	NXT Minimum, Low Pulse Width	See Figure 5	2.0			μS
t <sub>DIR_SET</sub>	NXT	NXT Hold Time, Following Change of DIR	See Figure 5	0.5			μs

<sup>11.</sup> Characterization Data Only 12. Guaranteed by design

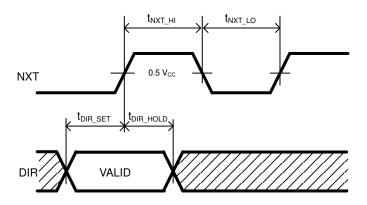
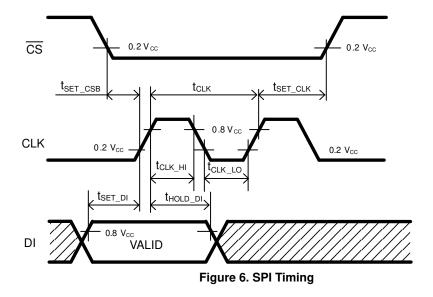


Figure 5. NXT-Input Timing Diagram

**Table 7. SPI TIMING PARAMETERS** 

Symbol	Parameter	Min	Тур	Max	Unit
t <sub>CLK</sub>	SPI Clock Period	1			μs
tclk_High	SPI Clock High Time	100			ns
t <sub>CLK_LOW</sub>	SPI Clock Low Time	100			ns
t <sub>SET_DI</sub>	DI Set Up Time, Valid Data Before Rising Edge of CLK	50			ns
thold_di	DI Hold Time, Hold Data After Rising Edge of CLK	50			ns
tcsb_High	CS High Time	2.5			μs
t <sub>SET_CSB</sub>	CS Set Up Time, CS Low Before Rising Edge of CLK	100			ns
t <sub>SET_CLK</sub>	CLK Set Up Time, CLK Low Before Rising Edge of CS	100			ns



## TYPICAL APPLICATION SCHEMATIC

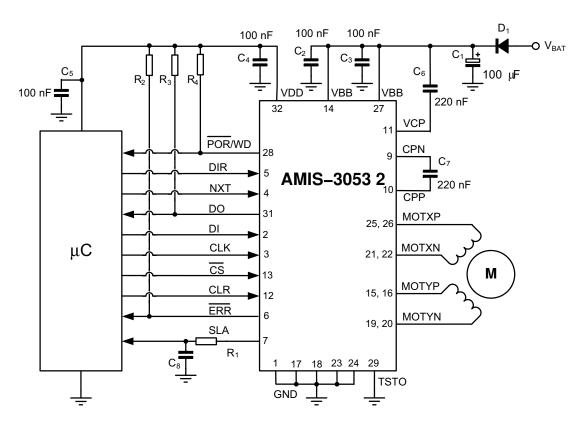


Figure 7. Typical Application Schematic AMIS-30532

**Table 8. EXTERNAL COMPONENTS LIST AND DESCRIPTION** 

Component	Function	Typ Value	Tolerance	Unit
C <sub>1</sub>	V <sub>BB</sub> Buffer Capacitor (Note 13)	100	-20 +80%	μF
C <sub>2</sub> , C <sub>3</sub>	V <sub>BB</sub> Decoupling Block Capacitor	100	-20 +80%	nF
C <sub>4</sub>	V <sub>DD</sub> Buffer Capacitor	100	± 20%	nF
C <sub>5</sub>	V <sub>DD</sub> Buffer Capacitor	100	± 20%	nF
C <sub>6</sub>	Charge Pump Buffer Capacitor	220	± 20%	nF
C <sub>7</sub>	Charge Pump Pumping Capacitor	220	± 20%	nF
C <sub>8</sub>	Low Pass Filter SLA	1	± 20%	nF
R <sub>1</sub>	Low Pass Filter SLA	5.6	±1%	kΩ
R <sub>2,</sub> R <sub>3,</sub> R <sub>4</sub>	Pullup Resistor Open Drain Output	4.7	± 1%	kΩ
D <sub>1</sub>	Optional Reverse Protection Diode	MURD530		

13. ESR < 1  $\Omega$ .

#### **FUNCTIONAL DESCRIPTION**

## **H-Bridge Drivers**

A full H-bridge is integrated for each of the two stator windings. Each H-bridge consists of two low-side and two high-side N-type MOSFET switches. Writing logic '0' in bit <MOTEN> disables all drivers (high-impedance). Writing logic '1' in this bit enables both bridges and current can flow in the motor stator windings.

In order to avoid large currents through the H-bridge switches, it is guaranteed that the top— and bottom—switches of the same half-bridge are never conductive simultaneously (interlock delay).

A two-stage protection against shorts on motor lines is implemented. In a first stage, the current in the driver is limited. Secondly, when excessive voltage is sensed across the transistor, the transistor is switched-off.

In order to reduce the radiated/conducted emission, voltage slope control is implemented in the output switches. The output slope is defined by the gate—drain capacitance of output transistor and the (limited) current that drives the gate. There are two trimming bits for slope control (see SPI Control Parameter Overview EMC[1:0]).

The power transistors are equipped with so-called "active diodes": when a current is forced trough the transistor switch in the reverse direction, i.e. from source to drain, then the transistor is switched on. This ensures that most of the current flows through the channel of the transistor instead of through the inherent parasitic drain-bulk diode of the transistor.

Depending on the desired current range and the micro-step position at hand, the R<sub>DS(on)</sub> of the low-side

transistors will be adapted such that excellent current–sense accuracy is maintained. The  $R_{DS(on)}$  of the high–side transistors remain unchanged, see Table 5 DC Parameters for more details.

#### **PWM Current Control**

A PWM comparator compares continuously the actual winding current with the requested current and feeds back the information to a digital regulation loop. This loop then generates a PWM signal, which turns on/off the H-bridge switches. The switching points of the PWM duty-cycle are synchronized to the on-chip PWM clock. The frequency of the PWM controller can be doubled and an artificial jitter can be added (see SPI Control Parameter Overview PWMJ). The PWM frequency will not vary with changes in the supply voltage. Also variations in motor-speed or load-conditions of the motor have no effect. There are no external components required to adjust the PWM frequency.

#### Automatic Forward and Slow-Fast Decay

The PWM generation is in steady-state using a combination of forward and slow-decay. The absence of fast-decay in this mode, guarantees the lowest possible current-ripple "by design". For transients to lower current levels, fast-decay is automatically activated to allow high-speed response. The selection of fast or slow decay is completely transparent for the user and no additional parameters are required for operation.

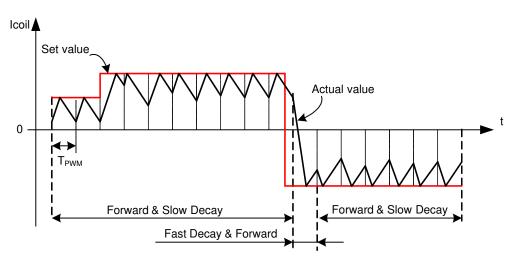


Figure 8. Forward and Slow/Fast Decay PWM

#### **Automatic Duty Cycle Adaptation**

In case the supply voltage is lower than 2\*Bemf, then the duty cycle of the PWM is adapted automatically to > 50% to maintain the requested average current in the coils. This

process is completely automatic and requires no additional parameters for operation. The over-all current-ripple is divided by two if PWM frequency is doubled (see SPI Control Parameter Overview PWMF).

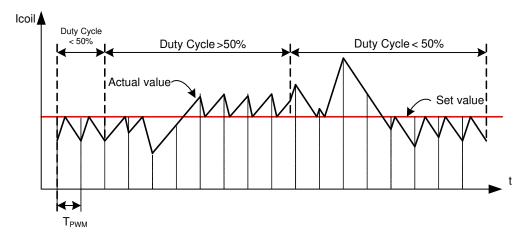


Figure 9. Automatic Duty Cycle Adaptation

## **Step Translator and Step Mode**

The step translator provides the control of the motor by means of SPI register Stepmode: SM[2:0], SPI register DIRCNTRL, and input pins DIR and NXT. It is translating consecutive steps in corresponding currents in both motor coils for a given step mode.

One out of seven possible stepping modes can be selected through SPI-bits SM[2:0] (see SPI Control Parameter Overview). After power—on or hard reset, the coil—current translator is set to the default 1/32 micro—stepping at position '0'. Upon changing the step mode, the translator jumps to position 0\* of the corresponding stepping mode.

When remaining in the same step mode, subsequent translator positions are all in the same column and increased or decreased with 1. Table 10 lists the output current versus the translator position.

As shown in Figure 10 the output current–pairs can be projected approximately on a circle in the  $(I_x, I_y)$  plane. There are, however, two exceptions: uncompensated half step and full step. In these step modes the currents are not regulated to a fraction of  $I_{max}$  but are in all intermediate steps regulated at 100%. In the  $(I_x, I_y)$  plane the current–pairs are projected on a square. Table 9 lists the output current versus the translator position for these cases.

Table 9. SQUARE TRANSLATOR TABLE FOR FULL STEP AND UNCOMPENSATED HALF STEP

	Stepmode ( SM[2:0	])	% of	I <sub>max</sub>
	101	110		
MSP[6:0]	Uncompensated Half-Step	Full Step	Coil x	Coil y
000 0000	0*	-	0	100
001 0000	1	1	100	100
010 0000	2	-	100	0
011 0000	3	2	100	-100
100 0000	4	-	0	-100
101 0000	5	3	-100	-100
110 0000	6	-	-100	0
111 0000	7	0	-100	100

**Table 10. CIRCULAR TRANSLATOR TABLE** 

			Stepmode (SM[2:0])			% of	I <sub>max</sub>
	000	001	010	011	100		
MSP[6:0]	1/32	1/16	1/8	1/4	1/2	Coil x	Coil y
000 0000	,0,	0*	0*	0*	0*	0	100
000 0001	1	_	-	-	-	3.5	98.8
000 0010	2	1	-	_	-	8.1	97.7
000 0011	3	-	-	-	-	12.7	96.5
000 0100	4	2	1	_	-	17.4	95.3
000 0101	5	-	-	-	-	22.1	94.1
000 0110	6	3	-	-	-	26.7	93
000 0111 000 1000	7 8	-	-	-	-	31.4	91.8
000 1000	9	<u>4</u>	2	1		34.9 38.3	89.5 87.2
000 1010	10	5	_	_	_	43	84.9
000 1011	11		-	_	-	46.5	82.6
000 1100	12	6	3	-	-	50	79
000 1101	13	-	-	-	-	54.6	75.5
000 1110	14	7	-	-	-	58.1	72.1
000 1111	15	-	-	_	-	61.6	68.6
001 0000	16	8	4	2	1	65.1	65.1
001 0001	17	-	-	-	-	68.6	61.6
001 0010	18	9	-	-	-	72.1	58.1
001 0011 001 0100	19 20	10	- 5	-		75.5 79	54.6 50
001 0100	21	-	-			82.6	46.5
001 0110	22	11	_	_	_	84.9	43
001 0111	23	-	-	-	-	87.2	38.3
001 1000	24	12	6	3	-	89.5	34.9
001 1001	25	-	-	-	-	91.8	31.4
001 1010	26	13	-	-	-	93	26.7
001 1011	27	-	-	-	-	94.1	22.1
001 1100	28	14	7	-	-	95.3	17.4
001 1101	29	- 15	-	-	-	96.5	12.7
001 1110	30 31	15 _	-			97.7 98.8	8.1 3.5
010 0000	32	16	8	4	2	100	0
010 0001	33		_			98.8	-3.5
010 0010	34	17	-	-	-	97.7	-8.1
010 0011	35	-	-	-	-	96.5	-12.7
010 0100	36	18	9	_	-	95.3	-17.4
010 0101	37	-	-	-	-	94.1	-22.1
010 0110	38	19	-	-	-	93	-26.7
010 0111	39	-	-	-	-	91.8	-31.4
010 1000 010 1001	40 41	20	10	5	-	89.5 87.2	-34.9 -38.3
010 1010	42	21	_		<del>-</del> -	84.9	-43
010 1011	43	-	_	_	-	82.6	-46.5
010 1100	44	22	11	-	-	79	-50
010 1101	45	-	-	-	-	75.5	-54.6
010 1110	46	23	-	-	-	72.1	-58.1
010 1111	47	-	-	-	-	68.6	-61.6
011 0000	48	24	12	6	3	65.1	-65.1
011 0001	49	-	-	_	-	61.6	-68.6
011 0010	50	25	-	-	-	58.1	-72.1
011 0011 011 0100	51 52	26	- 13	-	-	54.6 50	-75.5 -79
011 0100	53	_	-			46.5	-79 -82.6
011 0110	54	27	_	_	_	43	-84.9
011 0111	55	-	-	-	-	38.3	-87.2
011 1000	56	28	14	7	-	34.9	-89.5
011 1001	57	_	-	-	-	31.4	-91.8
011 1010	58	29	-	-	-	26.7	-93
011 1011	59	-	-	-	-	22.1	-94.1
011 1100	60	30	15	-	-	17.4	-95.3
011 1101	61	-	-	_	-	12.7	-96.5
011 1110	62	31	_	-	-	8.1	-97.7

Table 11. CIRCULAR TRANSLATOR TABLE (CONTINUED)

			Stepmode (SM[2:0])			% of	I <sub>max</sub>
	000	001	010	011	100		
MSP[6:0]	1/32	1/16	1/8	1/4	1/2	Coil x	Coil y
100 0000	64	32	16	8	4	0	-100
100 0001	65	_	-	_	-	-3.5	-98.8
100 0010	66	33	-	_	-	-8.1	-97.7
100 0011	67	_	-	_	-	-12.7	-96.5
100 0100	68	34	17	_	-	-17.4	-95.3
100 0101	69	_	-	_	-	-22.1	-94.1
100 0110	70	35	-	_	-	-26.7	-93
100 0111	71	-	-	-	-	-31.4	-91.8
100 1000	72	36	18	9	-	-34.9	-89.5
100 1001	73	-	-	-	-	-38.3	-87.2
100 1010	74	37	-	-	-	-43	-84.9
100 1011	75	_	-	-	-	-46.5	-82.6
100 1100	76	38	19	-	-	-50	-79
100 1101	77	-	-	-	-	-54.6	-75.5
100 1110	78	39	-	-	-	-58.1	-72.1
100 1111	79	-	-	-	-	-61.6	-68.6
101 0000	80	40	20	10	5	-65.1	-65.1
101 0001	81	-	-	-	-	-68.6	-61.6
101 0010	82	41	-	-	-	<del>-</del> 72.1	-58.1
101 0011	83	-	-	-	-	-75.5	-54.6
101 0100	84	42	21	-	-	<del>-</del> 79	-50
101 0101	85	_	-	-	-	-82.6	-46.5
101 0110	86	43	-	-	-	-84.9	-43
101 0111	87	_	-	-	-	-87.2	-38.3
101 1000	88	44	22	11	-	-89.5	-34.9
101 1001	89	_	-	-	-	-91.8	-31.4
101 1010	90	45	-	-	-	-93	-26.7
101 1011	91	_	-	-	-	-94.1	-22.1
101 1100	92	46	23	-	-	-95.3	-17.4
101 1101	93		-		-	-96.5	-12.7
101 1110	94	47	-		-	-97.7	-8.1
101 1111	95	-	-	-	-	-98.8	-3.5
110 0000	96	48	24	12	6	-100	0
110 0001	97	-	-	_	-	-98.8	3.5
110 0010	98 99	49	-	_	-	-97.7	8.1
110 0011 110 0100	100	- 50	- 25		-	-96.5 -95.3	12.7 17.4
110 0100	101	- 50		<u>-</u>		-95.3 -94.1	22.1
110 0110	102	51	_			-94.1 -93	26.7
110 0111	103	-	_		_	-91.8	31.4
110 1000	104	52	26	13		-89.5	34.9
110 1000	105	- -	-	-	_	-87.2	38.3
110 1010	106	53	_			-84.9	43
110 1011	107		_			-82.6	46.5
110 1100	108	54	27			-79	50
110 1101	109		-		_	-75.5	54.6
110 1110	110	55	_			-73.5 -72.1	58.1
110 1111	111		_	_	_	-68.6	61.6
111 0000	112	56	28	14	7	-65.1	65.1
111 0001	113	-	_	-	-	-61.6	68.6
111 0010	114	57	_	_	_	-58.1	72.1
111 0011	115		_	_	_	-54.6	75.5
111 0100	116	58	29	_	_	-50	79
111 0101	117		-	_	_	-46.5	82.6
111 0110	118	59	_	_	_	-43	84.9
111 0111	119	-	_	_	_	-38.3	87.2
111 1000	120	60	30	15	-	-34.9	89.5
111 1001	121	-	-	-	_	-31.4	91.8
111 1010	122	61	_	_	_	-26.7	93
111 1011	123	-	_	_	_	-22.1	94.1
111 1100	124	62	31	_	_	-17.4	95.3
	125		-	_	_	-12.7	96.5
111 1101	123	_				-14.7	
111 1101 111 1110	126	63	_		_	-8.1	97.7

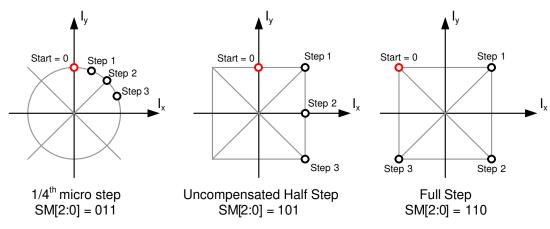


Figure 10. Translator Table: Circular and Square

#### Direction

The direction of rotation is selected by means of following combination of the DIR input pin and the SPI-controlled direction bit <DIRCTRL>. (see Table 14 SPI Control Parameter Overview)

## **NXT Input**

Changes on the NXT input will move the motor current one step up/down in the translator table (even when the motor is disabled <motten>=0>). Depending on the

NXT-polarity bit <NXTP> (see Table 14 SPI Control Parameter Overview), the next step is initiated either on the rising edge or the falling edge of the NXT input.

#### **Translator Position**

The translator position MSP[6:0] can be read in SPI Status Register 3 (See Table 15 SR3). This is a 7-bit number equivalent to the 1/32<sup>th</sup> micro-step from Table 10: Circular Translator Table. The translator position is updated immediately following a NXT trigger.

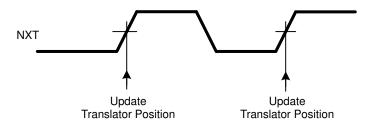


Figure 11. Translator Position Timing Diagram

#### Synchronization of Step Mode and NXT Input

When step mode is re-programmed to another resolution (Figure 12), then this is put in effect immediately upon the first arriving "NXT" input. If the micro-stepping resolution is increased, the coil currents will be regulated to the nearest micro-step, according to the fixed grid of the increased resolution. If however the micro-stepping resolution is decreased, then it is possible to introduce an offset (or phase shift) in the micro-step translator table.

If the step resolution is decreased at a translator table position that is shared both by the old and new resolution setting, then the offset is zero and micro-stepping is proceeds according to the translator table.

If the translator position is <u>not</u> shared both by the old and new resolution setting, then the micro-stepping proceeds with an offset relative to the translator table (See Figure 12 right hand side).

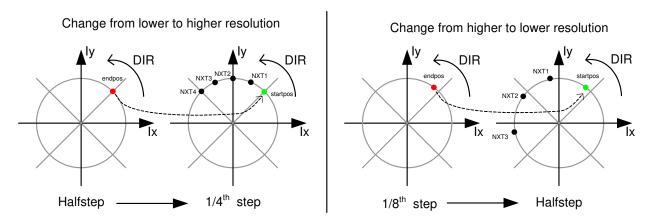


Figure 12. NXT-Step Mode Synchronization

**Left**: Change from lower to higher resolution. The left–hand side depicts the ending half–step position during which a new step mode resolution was programmed. The right–hand side diagram shows the effect of subsequent NXT commands on the micro–step position.

**Right**: Change from higher to lower resolution. The left–hand side depicts the ending micro–step position during which a new step mode resolution was programmed. The right–hand side diagram shows the effect of subsequent NXT commands on the half–step position.

**Note**: It is advised to reduce the micro–stepping resolution only at micro–step positions that overlap with desired micro–step positions of the new resolution.

## **Programmable Peak-Current**

The amplitude of the current waveform in the motor coils (coil peak current =  $I_{max}$ ) is adjusted by means of an SPI parameter "CUR[4:0]" (see Table 14 SPI Control Parameter

Overview). Whenever this parameter is changed, the coil-currents will be updated immediately at the next PWM period. Figure 13 presents the Peak-Current and Current Ratings in conjunction to the Current setting CUR[4:0].

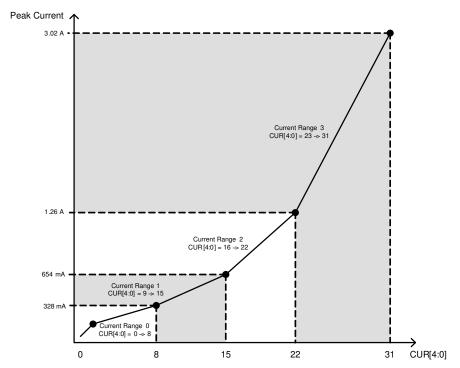


Figure 13. Programmable Peak-Current Overview

#### **Speed and Load Angle Output**

The SLA-pin provides an output voltage that indicates the level of the Back-e.m.f. voltage of the motor. This Back-e.m.f. voltage is sampled during every so-called "coil

current zero crossings". Per coil, two zero-current positions exist per electrical period, yielding in total four zero-current observation points per electrical period.

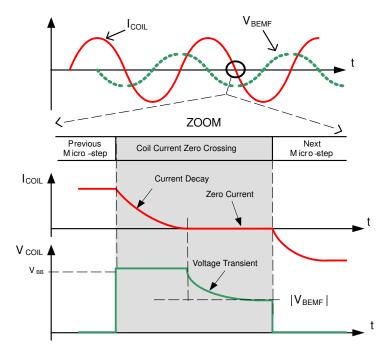


Figure 14. Principle of Bemf Measurement

Because of the relatively high recirculation currents in the coil during current decay, the coil voltage  $V_{COIL}$  shows a transient behavior. As this transient is not always desired in application software, two operating modes can be selected by means of the bit  $\langle SLAT \rangle$  (see "SLA–transparency" in see SPI Control Parameter Overview). The SLA pin shows in "transparent mode" full visibility of the voltage transient behavior. This allows a sanity–check of the speed–setting versus motor operation and characteristics and supply voltage levels. If the bit "SLAT" is cleared, then only the voltage samples at the end of each coil current zero crossing are visible on the SLA–pin. Because the transient behavior

of the coil voltage is not visible anymore, this mode generates smoother Back e.m.f. input for post-processing, e.g. by software.

In order to bring the sampled Back e.m.f. to a descent output level (0 V to 5 V), the sampled coil voltage  $V_{COIL}$  is divided by 2 or by 4. This divider is set through an SPI bit  $\langle SLAG \rangle$ . (see SPI Control Parameter Overview)

The following drawing illustrates the operation of the SLA-pin and the transparency-bit. "PWMsh" and " $I_{COIL}$  = 0" are internal signals that define together with SLAT the sampling and hold moments of the coil voltage.

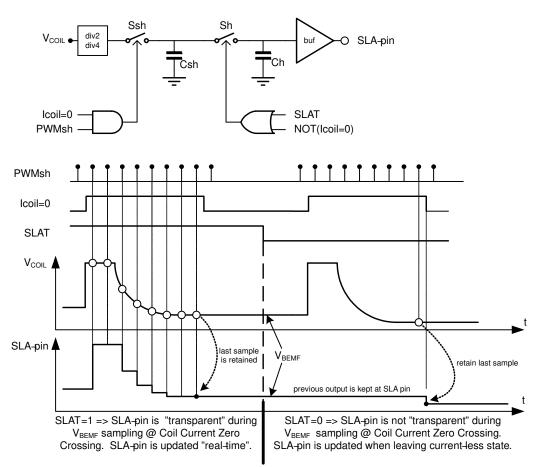


Figure 15. Timing Diagram of SLA-pin

## Warning, Error Detection and Diagnostics Feedback

## **Thermal Warning and Shutdown**

When junction temperature rises above  $T_{TW}$ , the thermal warning bit  $\langle \text{TW} \rangle$  is set (Table 16 SPI Status registers Address SR0). If junction temperature increases above thermal shutdown level, then the circuit goes in "Thermal Shutdown" mode ( $\langle \text{TSD} \rangle$ ) and all driver transistors are disabled (high impedance) (see Table 16 SPI Status registers Address SR2). The conditions to reset flag  $\langle \text{TSD} \rangle$  is to be at a temperature lower than  $T_{TW}$  and to clear the  $\langle \text{TSD} \rangle$  flag by reading it using any SPI read command.

#### **Overcurrent Detection**

The overcurrent detection circuit monitors the load current in each activated output stage. If the load current exceeds the overcurrent detection threshold, then the over-current flag is set and the drivers are switched off to reduce the power dissipation and to protect the integrated circuit. Each driver transistor has an individual detection bit in (see Table 16 SPI Status registers Address SR1 and SR2: <OVCXij> and <OVCYij>). Error condition is latched and the microcontroller needs to clean the status bits to reactivate the drivers.

**Note**: Successive reading the SPI StatusRegisters 1 and 2 in case of a short circuit condition, may lead to damage to the drivers.

## **Open Coil/Current Not Reached Detection**

Open coil detection is based on the observation of 100% duty cycle of the PWM regulator. If in a coil 100% duty cycle is detected for longer than 200 ms then the related driver transistors are disabled (high-impedance) and an appropriate bit in the SPI status register is set (<OPENX> or <OPENY>). (Table 16)

When the resistance of a motor coil is very large and the supply voltage is low, it can happen that the motor driver is not able to deliver the requested current to the motor. Under these conditions the PWM controller duty cycle will be 100% and after 200 ms the error pin and <OPENX>, <OPENY> will flag this situation (motor current is kept alive). This feature can be used to test if the operating conditions (supply voltage, motor coil resistance) still allow reaching the requested coil—current or else the coil current should be reduced.

#### **Charge Pump Failure**

The charge pump is an important circuit that guarantees low  $R_{DS(on)}$  for all drivers, especially for low supply

voltages. If supply voltage is too low or external components are not properly connected to guarantee  $R_{DS(on)}$  of the drivers, then the bit <CPFAIL> is set (Table 16). Also after POR the charge pump voltage will need some time to exceed the required threshold. During that time <CPFAIL> will be set to "1".

## **Error Output**

This is a digital output to flag a problem to the external microcontroller. The signal on this output is active low and the logic combination of:

NOT(ERRB) = <TW> OR <TSD> OR <OVCXij> OR <OVCYij> OR <OPENi> OR <CPFAIL>

#### **Logic Supply Regulator**

AMIS-30532 has an on-chip 5 V low-drop regulator with external capacitor to supply the digital part of the chip,

some low-voltage analog blocks and external circuitry. The voltage is derived from an internal bandgap reference. To calculate the available drive-current for external circuitry, the specified I<sub>load</sub> should be reduced with the consumption of internal circuitry (unloaded outputs) and the loads connected to logic outputs. See Table 5 DC Parameters.

#### Power-On Reset (POR) Function

The open drain output pin  $\overline{POR}/WD$  provides an "active low" reset for external purposes. At power-up of AMIS-30532, this pin will be kept low for some time to reset for example an external microcontroller. A small analog filter avoids resetting due to spikes or noise on the  $V_{DD}$  supply.

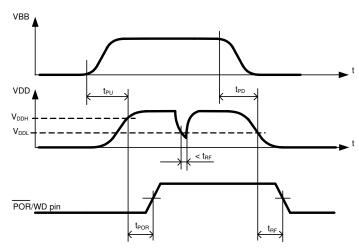


Figure 16. Power-on-Reset Timing Diagram

#### **Watchdog Function**

The watchdog function is enabled/disabled through <WDEN> bit (Table 13: SPI CONTROL REGISTERS (ALL SPI control registers have Read/Write Access and default to "0" after power—on or hard reset.)). Once this bit has been set to "1" (watchdog enable), the microcontroller needs to re—write this bit to clear an internal timer before the watchdog timeout interval expires. In case the timer is activated and WDEN is acknowledged too early (before twDPR) or not within the interval (after twDTO), then a reset of the microcontroller will occur through POR/WD pin. In addition, a warm/cold boot bit <WD> is available (see Tables 16 and 17) for further processing when the external microcontroller is alive again.

#### CLR Pin (=Hard Reset)

Logic 0 on CLR pin allows normal operation of the chip. To reset the complete digital inside AMIS–30532, the input CLR needs to be pulled to logic 1 during minimum time given by t<sub>CLR</sub>. (Table 6 AC Parameters). This reset function clears all internal registers without the need of a power–cycle, except in sleep mode. The operation of all

analog circuits is depending on the reset state of the digital, charge pump remains active. Logic 0 on CLR pin resumes normal operation again.

The voltage regulator remains functional during and after the reset and the POR/WD pin is not activated. Watchdog function is reset completely.

#### Sleep Mode

The bit <SLP> in SPI Control Register 2 (See Table 12) is provided to enter a so-called "sleep mode". This mode allows reduction of current-consumption when the motor is not in operation. The effect of sleep mode is as follows:

- The drivers are put in HiZ
- All analog circuits are disabled and in low-power mode
- All internal registers are maintaining their logic content
- NXT and DIR inputs are forbidden
- SPI communication remains possible (slight current increase during SPI communication)
- Reset of chip is possible through CLR pin

 Oscillator and digital clocks are silent, except during SPI communication

The voltage regulator remains active but with reduced current-output capability (I<sub>LOADSLP</sub>). The watchdog timer stops running and it's value is kept in the counter. Upon

leaving sleep mode, this timer continues from the value it had before entering sleep mode.

Normal operation is resumed after writing logic '0' to bit <SLP>. A start—up time is needed for the charge pump to stabilize. After this time, NXT commands can be issued.

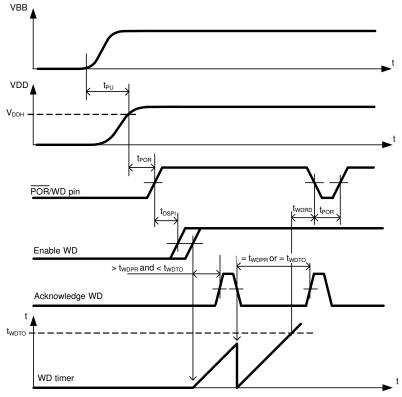


Figure 17. Watchdog Timing Diagram

Note: t<sub>DSPI</sub> is the time needed by the external microcontroller to shift–in the <WDEN> bit after a power–up.

The duration of the watchdog timeout interval is programmable through the WDT[3:0] bits (See also Table 13: SPI CONTROL REGISTERS (ALL SPI control registers have Read/Write Access and default to "0" after power—on or hard reset.). The timing is given in Table 12 below.

Table 10 WATCHDOC TIMEOUT INTERVAL	AC ELINICTION OF WIDTER OF
Table 12. WATCHDOG TIMEOUT INTERVAL	AS FUNCTION OF WUTIS.UL

Inde	x WDT[3:0]	t <sub>WDTO</sub> (ms)	Inde	x WDT[3:0]	t <sub>WDTO</sub> (ms)	
0	0000	32	8	1000	288	
1	0001	64	9	1001	320	
2	0010	96	10	1010	352	
3	0011	128	11	1011	384	
4	0100	160	12	1100	416	
5	0101	192	13	1101	448	
6	0110	224	14	1110	480	
7	0111	256	15	1111	512	

#### **SPI INTERFACE**

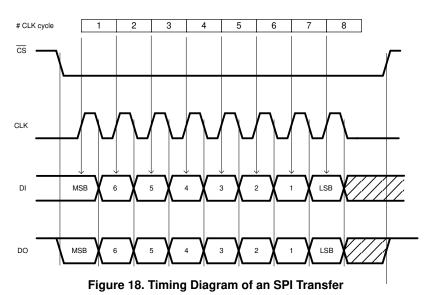
The serial peripheral interface (SPI) allows an external microcontroller (Master) to communicate with AMIS-30532. The implemented SPI block is designed to interface directly with numerous micro-controllers from several manufacturers. AMIS-30532 acts always as a Slave and can't initiate any transmission. The operation of the device is configured and controlled by means of SPI registers which are observable for read and/or write from the Master.

#### **SPI Transfer Format and Pin Signals**

During a SPI transfer, data is simultaneously transmitted (shifted out serially) and received (shifted in serially). A serial clock line (CLK) synchronizes shifting and sampling of the information on the two serial data lines (DO and DI).

DO signal is the output from the Slave (AMIS–30532), and DI signal is the output from the Master. A chip select line  $(\overline{CS})$  allows individual selection of a Slave SPI device in a multiple–slave system. The  $\overline{CS}$  line is active low. If AMIS–30532 is not selected, DO is pulled up with the external pull up resistor. Since AMIS–30532 operates as a Slave in MODE 0 (CPOL = 0; CPHA = 0) it always clocks data out on the falling edge and samples data in on rising edge of clock. The Master SPI port must be configured in MODE 0 too, to match this operation. The SPI clock idles low between the transferred bytes.

The diagram below is both a Master and a Slave timing diagram since CLK, DO and DI pins are directly connected between the Master and the Slave.



NOTE: At the falling edge of the eight clock pulse the data–out shift register is updated with the content of the addressed internal SPI register. The internal SPI registers are updated at the first rising edge of the AMIS–30532 system clock when  $\overline{CS}$  = High

#### **Transfer Packet**

Serial data transfer is assumed to follow MSB first rule. The transfer packet contains one or more 8-bit characters (bytes).

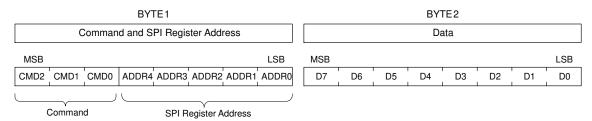


Figure 19. SPI Transfer Packet

Byte 1 contains the Command and the SPI Register Address and indicates to AMIS-30532 the chosen type of operation and addressed register. Byte 2 contains data, or

sent from the Master in a WRITE operation, or received from AMIS-30532 in a READ operation.

Two command types can be distinguished in the communication between master and AMIS-30532:

- READ from SPI Register with address ADDR[4:0]:
   CMD2 = "0"
- WRITE to SPI Register with address ADDR[4:0]: CMD2 = "1"

## **READ Operation**

If the Master wants to read data from Status or Control Registers, it initiates the communication by sending a READ command. This READ command contains the address of the SPI register to be read out. At the falling edge of the eight clock pulse the data—out shift register is updated with the content of the corresponding internal SPI register. In the next 8-bit clock pulse train this data is shifted out via DO pin. At the same time the data shifted in from DI (Master) should be interpreted as the following successive command or dummy data.

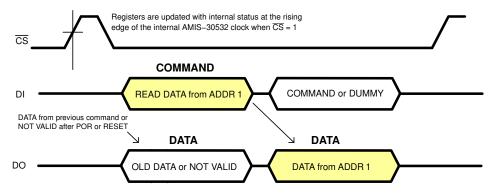


Figure 20. Single READ Operation where DATA from SPI register with Address 1 is read by the Master

All 4 Status Registers (see SPI Registers) contain 7 data bits and a parity check bit The most significant bit (D7) represents a parity of D[6:0]. If the number of logical ones in D[6:0] is odd, the parity bit D7 equals "1". If the number of logical ones in D[6:0] is even then the parity bit D7 equals "0". This simple mechanism protects against noise and increases the consistency of the transmitted data. If a parity check error occurs it is recommended to initiate an additional READ command to obtain the status again.

Also the Control Registers can be read out following the same routine. Control Registers don't have a parity check.

The  $\overline{CS}$  line is active low and may remain low between successive READ commands as illustrated in Figure 22. There is however one exception. In case an error condition is latched in one of Status Registers (see SPI Registers) the ERRB pin is activated. (See Section Error Output). This signal flags a problem to the external microcontroller. By reading the Status Registers information about the root cause of the problem can be determined. After this READ operation the Status Registers are cleared. Because the Status Registers and ERRB pin (see SPI Registers) are only updated by the internal system clock when the  $\overline{CS}$  line is

high, the Master should force  $\overline{CS}$  high immediately after the READ operation. For the same reason it is recommended to keep the  $\overline{CS}$  line high always when the SPI bus is idle.

## **WRITE Operation**

If the Master wants to write data to a Control Register it initiates the communication by sending a WRITE command. This contains the address of the SPI register to write to. The command is followed with a data byte. This incoming data will be stored in the corresponding Control Register after  $\overline{\text{CS}}$  goes from low to high! AMIS-30532 responds on every incoming byte by shifting out via DO the data stored in the last received address.

It is important that the writing action (command – address and data) to the Control Register is exactly 16 bits long. If more or less bits are transmitted the complete transfer packet is ignored.

A WRITE command executed for a read-only register (e.g. Status Registers) will not affect the addressed register and the device operation.

Because after a power-on-reset the initial address is unknown the data shifted out via DO is not valid.

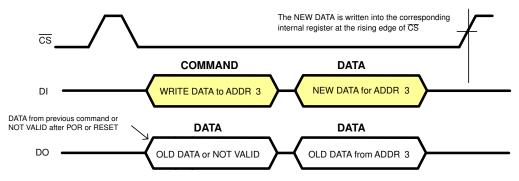


Figure 21. Single WRITE Operation where DATA from the Master is written in SPI register with Address 3

# **Examples of Combined READ and WRITE Operations**

In the following examples successive READ and WRITE operations are combined. In Figure 22 the Master first reads the status from Register at ADDR4 and at ADDR5 followed

by writing a control byte in Control Register at ADDR2. Note that during the write command the old data of the pointed register is returned at the moment the new data is shifted in.

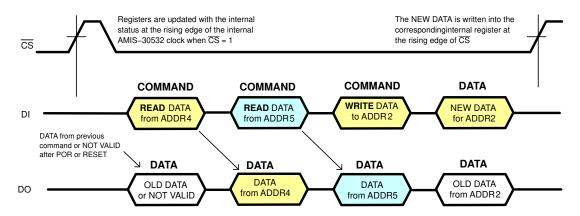


Figure 22. 2 Successive READ Commands Followed by a WRITE Command

After the write operation the Master could initiate a read back command in order to verify the data correctly written as illustrated in Figure 23. During reception of the READ command the old data is returned for a second time. Only after receiving the READ command the new data is

transmitted. This rule also applies when the master device wants to initiate an SPI transfer to read the Status Registers. Because the internal system clock updates the Status Registers only when  $\overline{CS}$  line is high, the first read out byte might represent old status information.

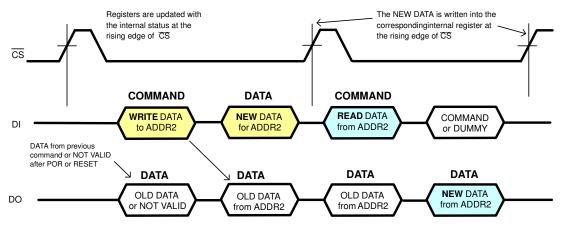


Figure 23. A WRITE Operation Where DATA from the Master is Written in SPI Register with Address 2 Followed by a READ Back Operation to Confirm a Correct WRITE Operation

NOTE: The internal data–out shift buffer of AMIS–30532 is updated with the content of the selected SPI register only at the last (every eight) falling edge of the CLK signal (see SPI Transfer Format and Pin Signals). As a result, new data for transmission cannot be written to the shift buffer at the beginning of the transfer packet and the first byte shifted out might represent old data.

**Table 13. SPI CONTROL REGISTERS** (All SPI control registers have Read/Write Access and default to "0" after power–on or hard reset)

		Structure							
	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Reset	0	0	0	0	0	0	0	0
WR (00h)	Data	WDEN	WDT[3:0]			-	-	-	
CR0 (01h)	Data		SM[2:0]			CUR[4:0]			
CR1 (02h)	Data	DIRCTRL	NXTP	-	-	PWMF	PWMF PWMJ EMC[1:0]		
CR2 (03h)	Data	MOTEN	SLP	SLAG	SLAT	-	-	-	-
CR2 (08h)	Data	M[1	:0]	StrB[1:0] – StrC StrE[1:0]			[1:0]		

Where:

R/W Read and Write access

Reset: Status after power-On or hard reset

**Table 14. SPI CONTROL PARAMETER OVERVIEW** 

Symbol	Description	S	tatus	Value	
		<dir> = 0</dir>	<dirctrl> = 0</dirctrl>	CW motion (Note 15)	
DIRCTRL	Controls the direction of rotation (in combination		<dirctrl> = 1</dirctrl>	CCW motion (Note 15	
	with logic level on input DIR)	<dir> = 1</dir>	<dirctrl> = 0</dirctrl>	CCW motion (Note 15	
			<dirctrl> = 1</dirctrl>	CW motion (Note 15)	
NIVED.		<nxtp> = 0</nxtp>	Trigger o	on rising edge	
NXTP	Selects if NXT triggers on rising or falling edge	<nxtp> = 1</nxtp>	Trigger o	n falling edge	
	Turn On – Turn–off Slopes of motor driver (Note 14)	00	Very Fast		
EMC[1:0]		01		Fast	
		10		Slow	
		11	Very Slow		
		<slat> = 0</slat>	SLA is transparent		
SLAT	Speed load angle transparency bit	<slat> = 1</slat>	SLA is NOT transparent		
		<slag> = 0</slag>	Gain = 0.5		
SLAG	Speed load angle gain setting	<slag> = 1</slag>	Gain = 0.25		
		<pwmf> = 0</pwmf>	Default Frequency		
PWMF	Enables doubling of the PWM frequency (Note 14)	<pwmf> = 1</pwmf>	Double Frequency		
		<pwmj> = 0</pwmj>	Jitter disabled		
PWMJ	Enables jittery PWM	<pwmj> = 1</pwmj>	Jitter enabled		
		000	1/32 Micro – Step		
		001	1/16 Micro – Step		
		010	1/8 Micro – Step		
		011	1/4 Micro – Step		
SM[2:0]	Stepmode	100	Compensated Half Step		
		101	Uncompensated Half Step		
		110	Full Step		
		111	n.a.		
		<slp> = 0</slp>	Active mode		
SLP	SLP Enables sleep mode		Sleep mode		
		<moten> = 0</moten>	Drivers disabled		
MOTEN	Activates the motor driver outputs	<moten> = 1</moten>	Drivers enabled		
		00	Default	PWM control	
		01	DCMin Mode 1		
M[1:0]	PWM Mode Control	10	DCMin Mode 2		
		11	DCMin Mode 3		
	PWM Strobe B Control: DON mask comparator time (Note 16)	00	4 PWM clock cycles		
		01	8 PWM clock cycles		
StrB[1:0]		10	12 PWM clock cycles		
		11	19 PWM clock cycles		
	PWM Strobe C Control: Switch time top/bottom	<strc> = 0</strc>	86% duty cycle PWM regulator		
StrC	regulation	<strc> = 1</strc>	75% duty cycle PWM regulator		
		00	4 PWM clock cycles		
	DIMM Stroke E Control Common and the bridge	01		clock cycles	
StrE[1:0]	PWM Strobe E Control: Compensation bridge active time (Note 16)	10	12 PWM clock cycles		
			12 1 7717	. 5.551 0,5100	

<sup>14.</sup> The typical values can be found in Table 5: DC Parameters and in Table 6: AC parameters 15. Depending on the wiring of the motor connections 16. The duration is depending on the selected PWM frequency